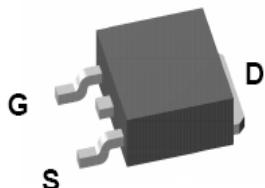


## P0903BD

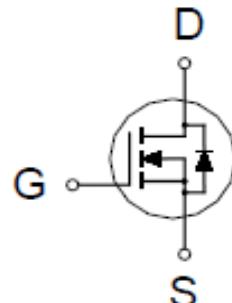
### N-Channel Enhancement Mode MOSFET

#### PRODUCT SUMMARY

$V_{(BR)DSS}$	$R_{DS(ON)}$	$I_D$
30V	9mΩ @ $V_{GS} = 10V$	57A



TO-252



#### ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ C$ Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS	SYMBOL	LIMITS	UNITS
Drain-Source Voltage	$V_{DS}$	30	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	
Continuous Drain Current $T_C = 25^\circ C$	$I_D$	57	A
		36	
Pulsed Drain Current <sup>1</sup>	$I_{DM}$	160	
Avalanche Current	$I_{AS}$	34	
Avalanche Energy	$E_{AS}$	60	mJ
Power Dissipation $T_C = 25^\circ C$	$P_D$	49	W
		19	
Junction & Storage Temperature Range	$T_j, T_{stg}$	-55 to 150	°C
Lead Temperature(1/16" from case for 10 sec)	$T_L$	275	

#### THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNITS
Junction-to-Case	$R_{\theta JC}$		2.55	°C / W
Junction-to-Ambient	$R_{\theta JA}$		63	

<sup>1</sup>Pulse width limited by maximum junction temperature.

## P0903BD N-Channel Enhancement Mode MOSFET

### ELECTRICAL CHARACTERISTICS ( $T_J = 25^\circ\text{C}$ , Unless Otherwise Noted)

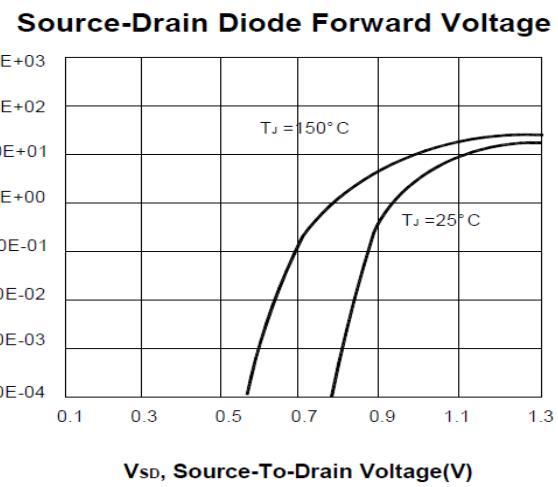
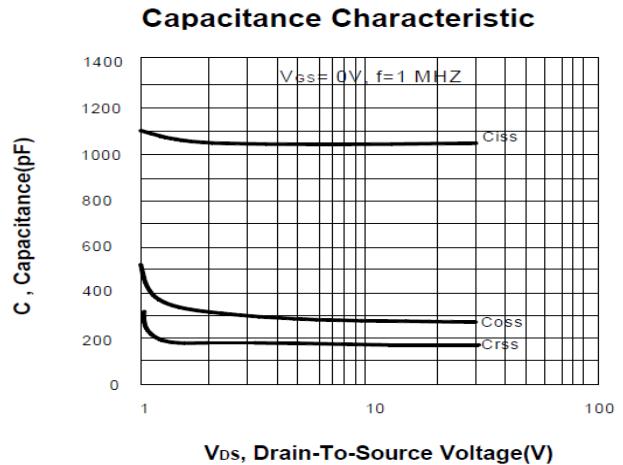
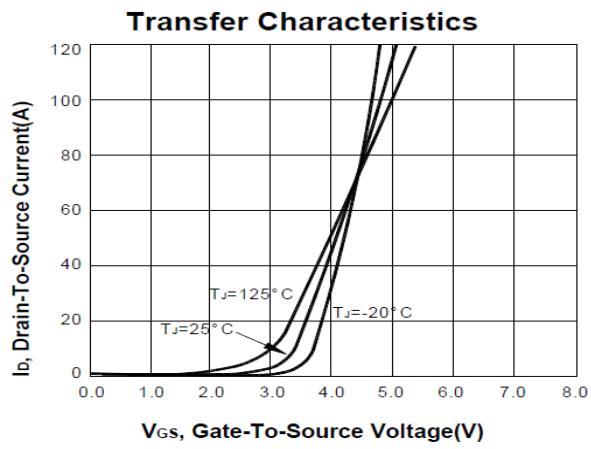
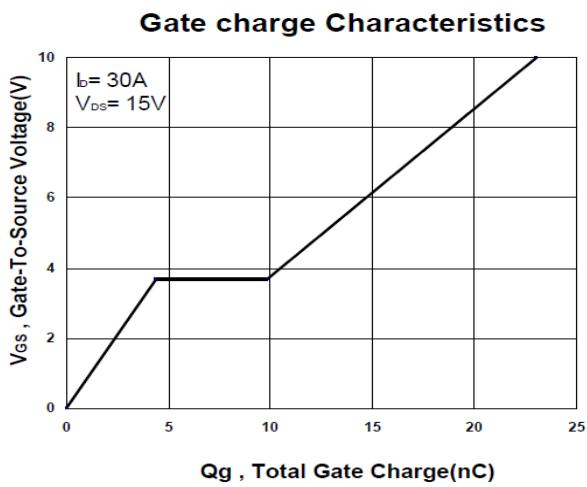
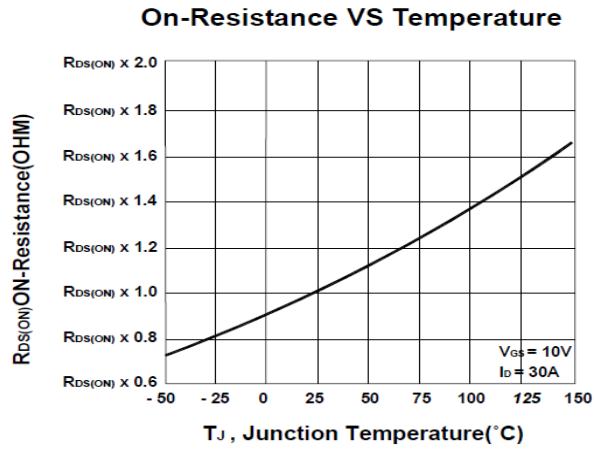
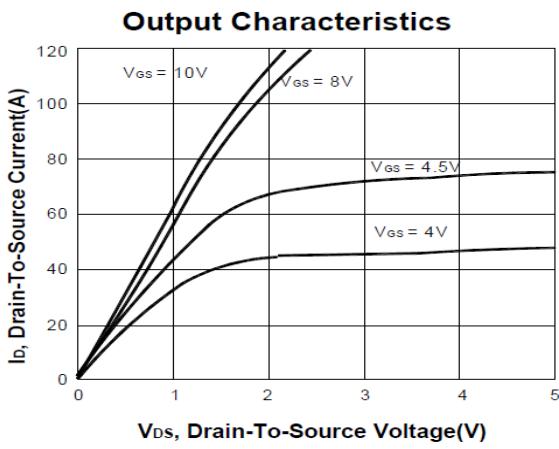
PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNITS
			MIN	TYP	MAX	
<b>STATIC</b>						
Drain-Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_D = 250\mu\text{A}$	30			V
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}} = V_{\text{GS}}, I_D = 250\mu\text{A}$	1	1.5	3	
Gate-Body Leakage	$I_{\text{GSS}}$	$V_{\text{DS}} = 0\text{V}, V_{\text{GS}} = \pm 20\text{V}$			$\pm 100$	nA
Zero Gate Voltage Drain Current	$I_{\text{DSS}}$	$V_{\text{DS}} = 24\text{V}, V_{\text{GS}} = 0\text{V}$			1	$\mu\text{A}$
		$V_{\text{DS}} = 20\text{V}, V_{\text{GS}} = 0\text{V}, T_J = 125^\circ\text{C}$			10	
On-State Drain Current <sup>1</sup>	$I_{\text{D}(\text{ON})}$	$V_{\text{DS}} = 10\text{V}, V_{\text{GS}} = 10\text{V}$	160			A
Drain-Source On-State Resistance <sup>1</sup>	$R_{\text{DS}(\text{ON})}$	$V_{\text{GS}} = 4.5\text{V}, I_D = 30\text{A}$		11	13	$\text{m}\Omega$
		$V_{\text{GS}} = 10\text{V}, I_D = 30\text{A}$		7	9	
Forward Transconductance <sup>1</sup>	$g_{\text{fs}}$	$V_{\text{DS}} = 15\text{V}, I_D = 17\text{A}$		60		S
<b>DYNAMIC</b>						
Input Capacitance	$C_{\text{iss}}$	$V_{\text{GS}} = 0\text{V}, V_{\text{DS}} = 15\text{V}, f = 1\text{MHz}$		1060		pF
Output Capacitance	$C_{\text{oss}}$			281		
Reverse Transfer Capacitance	$C_{\text{rss}}$			175		
Gate Resistance	$R_g$	$V_{\text{GS}} = 0\text{V}, V_{\text{DS}} = 0\text{V}, f = 1\text{MHz}$		1.41		$\Omega$
Total Gate Charge <sup>2</sup>	$Q_g$	$V_{\text{DS}} = 0.5V_{(\text{BR})\text{DSS}}, V_{\text{GS}} = 10\text{V}, I_D = 30\text{A}$		23		nC
Gate-Source Charge <sup>2</sup>	$Q_{\text{gs}}$			4.4		
Gate-Drain Charge <sup>2</sup>	$Q_{\text{gd}}$			5.5		
Turn-On Delay Time <sup>2</sup>	$t_{\text{d}(\text{on})}$	$V_{\text{DS}} = 15\text{V}, R_L = 15\Omega$ $I_D \cong 1\text{A}, V_{\text{GS}} = 10\text{V}, R_{\text{GEN}} = 6\Omega$		16		nS
Rise Time <sup>2</sup>	$t_r$			25		
Turn-Off Delay Time <sup>2</sup>	$t_{\text{d}(\text{off})}$			60		
Fall Time <sup>2</sup>	$t_f$			16		
<b>SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (<math>T_J = 25^\circ\text{C}</math>)</b>						
Continuous Current	$I_S$				32	A
Forward Voltage <sup>1</sup>	$V_{\text{SD}}$	$I_F = I_S, V_{\text{GS}} = 0\text{V}$			1.3	V
Reverse Recovery Time	$t_{\text{rr}}$	$I_F = 3\text{A}, dI_F/dt = 100\text{A}/\mu\text{s}$		40	70	nS
Reverse Recovery Charge	$Q_{\text{rr}}$			28		nC

<sup>1</sup>Pulse test : Pulse Width  $\leq 300\ \mu\text{sec}$ , Duty Cycle  $\leq 2\%$ .

<sup>2</sup>Independent of operating temperature.

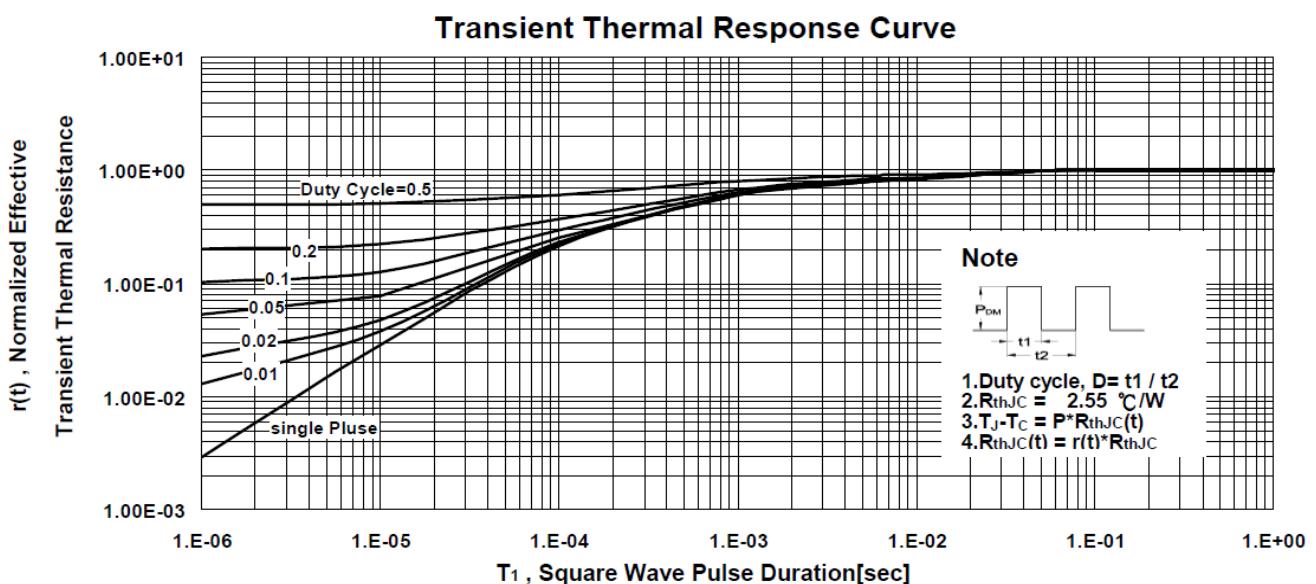
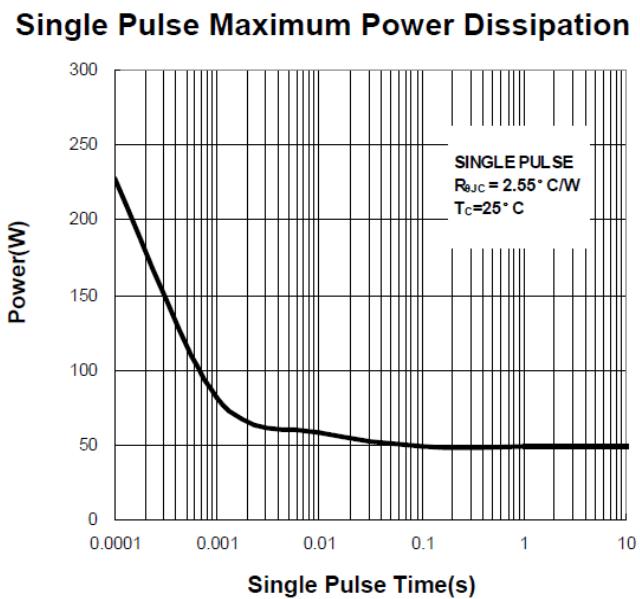
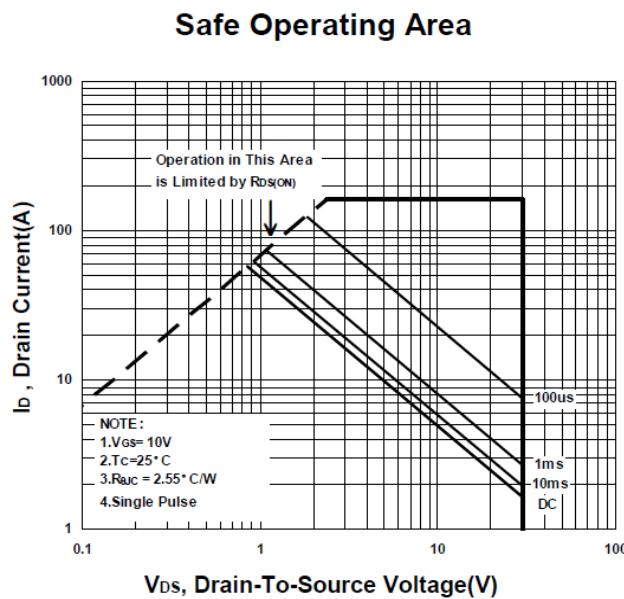
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### N-Channel Enhancement Mode MOSFET



## P0903BD

### N-Channel Enhancement Mode MOSFET



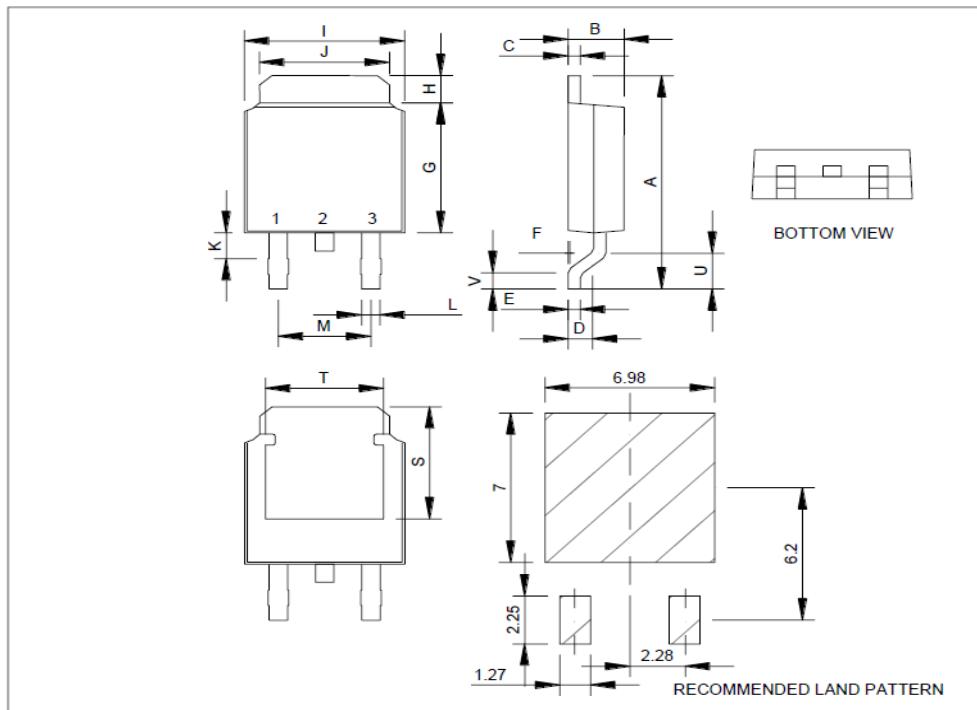
## P0903BD

### N-Channel Enhancement Mode MOSFET

#### Package Dimension

#### TO-252 (DPAK) MECHANICAL DATA

Dimension	mm			Dimension	mm		
	Min.	Typ.	Max.		Min.	Typ.	Max.
A	8.9	10	10.41	J	4.8		5.64
B	2.1	2.2	2.4	K	0.15		1.1
C	0.4	0.5	0.61	L	0.4	0.76	0.89
D	0.82	1.2	1.5	M	4.2	4.58	5
E	0.4	0.5	0.61	S	4.9	5.1	5.3
F	0		0.2	T	4.6	4.75	5.44
G	5.3	6.1	6.3	U	1.4		1.78
H	0.9		1.7	V	0.55	1.25	1.7
I	6.3	6.5	6.8				



\*因为各家封装模具不同而外观略有差异，不影响电性及Layout。